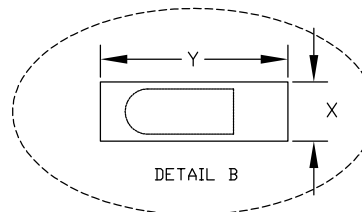
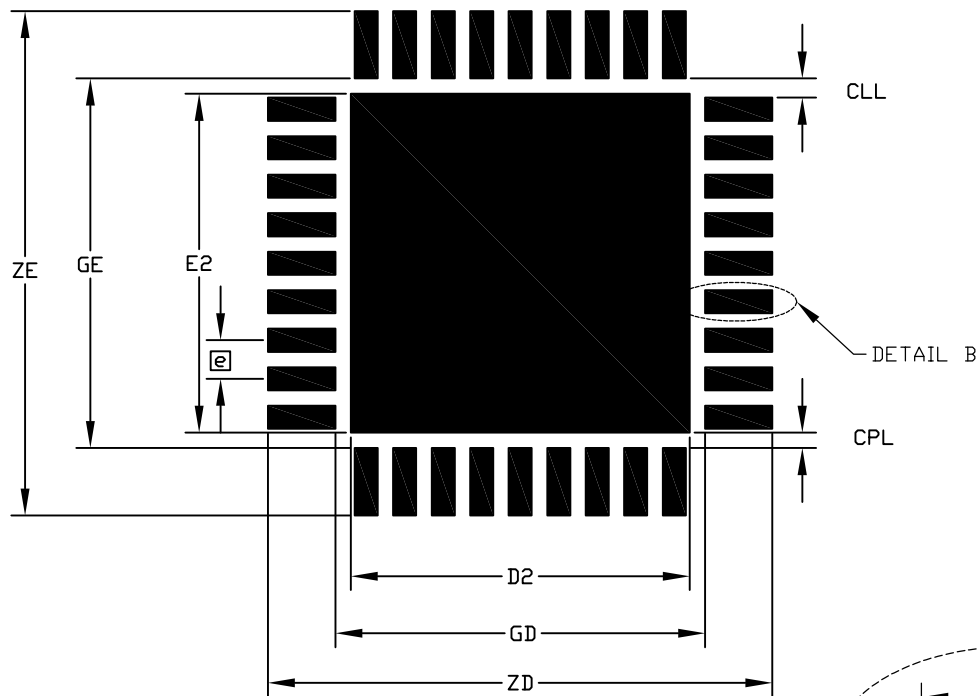


## RECOMMENDED LAND PATTERN

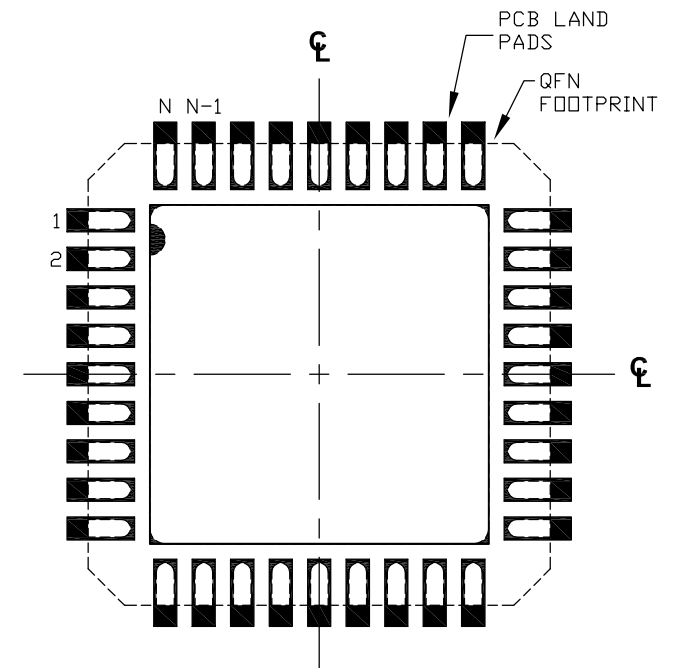


### NOTES:

1. REFERENCE PKG. OUTLINE: 21-1009
2. LAND PATTERN COMPLIES TO: IPC7351A.
3. TOLERANCE: +/- 0.02 MM.
4. ALL DIMENSIONS APPLY TO PbFREE (+) PKG. CODE ONLY.
5. ALL DIMENSIONS IN MM.
6. CLL IS THE CORNER PAD EDGE TO ADJACENT INSIDE PAD DISTANCE.
7. CPL IS THE CENTRAL PAD TO INSIDE EDGE OF LEAD PAD DISTANCE.

—DRAWING NOT TO SCALE—

## QFN OVERLAY



DIM	MILLIMETERS			INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
CLL		0.25 REF		0.010 REF		
CPL		0.20 REF		0.008 REF		
D2		4.40 REF		0.173 REF		
E2		4.40 REF		0.173 REF		
e		0.50 BSC		0.020 BSC		
GD		4.80 REF		0.189 REF		
GE		4.80 REF		0.189 REF		
N		36 PINS		36 PINS		
X		0.30 TYP		0.012 TYP		
Y		0.88 TYP		0.034 TYP		
ZD		6.55 REF		0.258 REF		
ZE		6.55 REF		0.258 REF		



TITLE:  
PACKAGE LAND PATTERN,  
[G3666+2] PUNCH QFN

APPROVAL	DOCUMENT CONTROL NO. 90-0513	REV. A	1/1
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This document (including dimensions, notes & specs) is a recommendation based on typical circuit board manufacturing parameters. Since land pattern design depend on many factors unknown to Maxim (eg. user's board manufacturing specs), user must determine suitability for use. This document is subject to change without notice. Contact technical support at <http://www.maximintegrated.com/support> for further questions.